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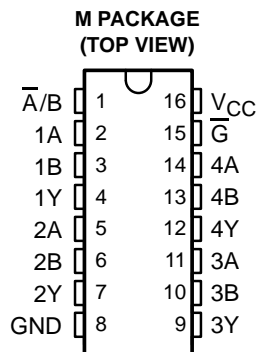
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QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER

SCHS336 – MARCH 2003

- AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply Voltage
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- ±24-mA Output Drive Current – Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015



description/ordering information

This quadruple 2-line to 1-line data selector/multiplexer is designed for 1.5-V to 5.5-V V_{CC} operation.

The CD74AC158 features a common strobe (\bar{G}) input. When the strobe is high, all outputs are high. When the strobe is low, a 4-bit word is selected from one of two sources and is routed to the four outputs. This device provides inverted data.

ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------|------|-----------------------|------------------|
| -55°C to 125°C | SOIC – M | Tube | CD74AC158M | AC158M |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE
(each data selector/multiplexer)

| \bar{G} | INPUTS | | | OUTPUT Y |
|-----------|-------------|---|---|-------------|
| | $\bar{A/B}$ | A | B | |
| H | X | X | X | H |
| L | L | L | X | H |
| L | L | H | X | L |
| L | H | X | L | H |
| L | H | X | H | L |



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



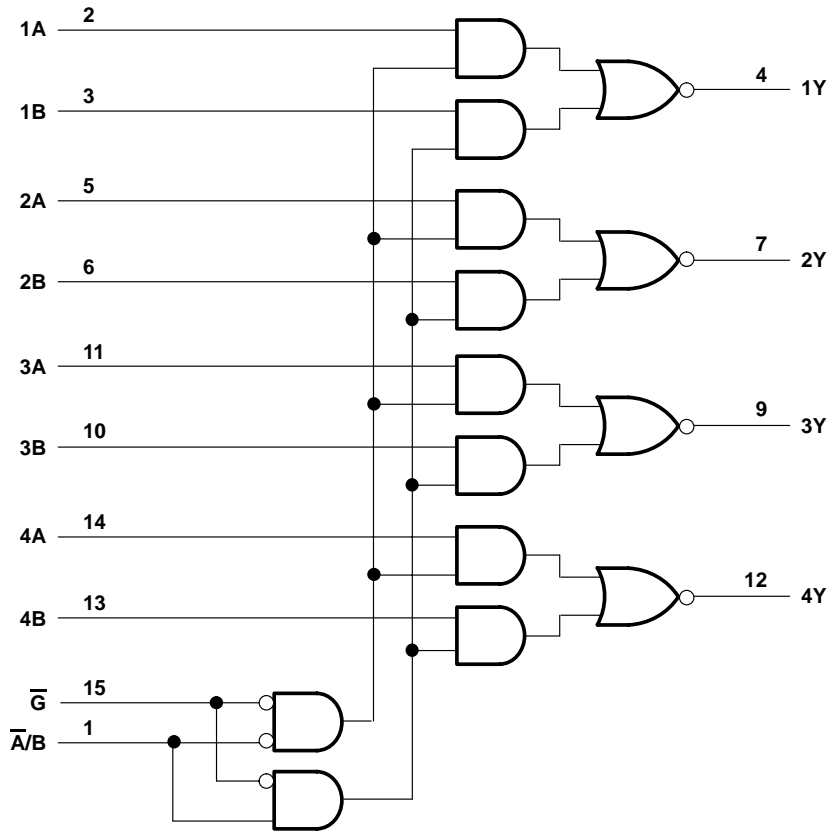
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CD74AC158
QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------|
| Supply voltage range, V_{CC} | -0.5 V to 6 V |
| Input clamp current, I_{IK} ($V_I < 0$ V or $V_I > V_{CC}$) (see Note 1) | ± 20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ V or $V_O > V_{CC}$) (see Note 1) | ± 50 mA |
| Continuous output current, I_O ($V_O > 0$ V or $V_O < V_{CC}$) | ± 50 mA |
| Continuous current through V_{CC} or GND | ± 100 mA |
| Package thermal impedance, θ_{JA} (see Note 2) | 73°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 3)

| | | T _A = 25°C | | -55°C to 125°C | | -40°C to 85°C | | UNIT |
|-----------------|------------------------------------|----------------------------------|-----------------|----------------|-----------------|---------------|-----------------|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | 1.5 | 5.5 | 1.5 | 5.5 | 1.5 | 5.5 | V |
| V _{IH} | High-level input voltage | V _{CC} = 1.5 V | | 1.2 | 1.2 | 1.2 | | V |
| | | V _{CC} = 3 V | | 2.1 | 2.1 | 2.1 | | |
| | | V _{CC} = 5.5 V | | 3.85 | 3.85 | 3.85 | | |
| V _{IL} | Low-level input voltage | V _{CC} = 1.5 V | | | 0.3 | | 0.3 | V |
| | | V _{CC} = 3 V | | | 0.9 | | 0.9 | |
| | | V _{CC} = 5.5 V | | | 1.65 | | 1.65 | |
| V _I | Input voltage | 0 | V _{CC} | 0 | V _{CC} | 0 | V _{CC} | V |
| V _O | Output voltage | 0 | V _{CC} | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | V _{CC} = 4.5 V to 5.5 V | | -24 | -24 | -24 | | mA |
| I _{OL} | Low-level output current | V _{CC} = 4.5 V to 5.5 V | | 24 | 24 | 24 | | mA |
| Δt/Δv | Input transition rise or fall rate | V _{CC} = 1.5 V to 3 V | | 50 | 50 | 50 | | ns/V |
| | | V _{CC} = 3.6 V to 5.5 V | | 20 | 20 | 20 | | |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | -55°C to 125°C | | -40°C to 85°C | | UNIT |
|-----------------|---|---------------------------------------|-----------------------|------|----------------|------|---------------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | V _I = V _{IH} or V _{IL} | I _{OH} = -50 μA | 1.5 V | 1.4 | 1.4 | 1.4 | | V | |
| | | | 3 V | 2.9 | 2.9 | 2.9 | | | |
| | | | 4.5 V | 4.4 | 4.4 | 4.4 | | | |
| | | I _{OH} = -4 mA | 3 V | 2.58 | 2.4 | 2.48 | | | |
| | | I _{OH} = -24 mA | 4.5 V | 3.94 | 3.7 | 3.8 | | | |
| | | I _{OH} = -50 mA [†] | 5.5 V | | 3.85 | | | | |
| V _{OL} | V _I = V _{IH} or V _{IL} | I _{OL} = 50 μA | 1.5 V | 0.1 | 0.1 | 0.1 | | V | |
| | | | 3 V | 0.1 | 0.1 | 0.1 | | | |
| | | | 4.5 V | 0.1 | 0.1 | 0.1 | | | |
| | | I _{OL} = 12 mA | 3 V | 0.36 | 0.5 | 0.44 | | | |
| | | I _{OL} = 24 mA | 4.5 V | 0.36 | 0.5 | 0.44 | | | |
| | | I _{OL} = 50 mA [†] | 5.5 V | | 1.65 | | | | |
| | | I _{OL} = 75 mA [†] | 5.5 V | | | 1.65 | | | |
| I _I | V _I = V _{CC} or GND | 5.5 V | | ±0.1 | ±1 | ±1 | | μA | |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | 8 | 160 | 80 | | μA | |
| C _i | | | | 10 | 10 | 10 | | pF | |

[†] Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

CD74AC158 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 1.5\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | -55°C to 125°C | | -40°C to 85°C | | UNIT |
|------------------|--------------|-------------|----------------|-----|---------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | A or B | Any Y | 100 | | 91 | | ns |
| t _{PHL} | | | 100 | | 91 | | |
| t _{PLH} | \bar{A}/B | Any Y | 161 | | 147 | | ns |
| t _{PHL} | | | 161 | | 147 | | |
| t _{PLH} | \bar{G} | Any Y | 149 | | 135 | | ns |
| t _{PHL} | | | 149 | | 135 | | |

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | -55°C to 125°C | | -40°C to 85°C | | UNIT |
|------------------|--------------|-------------|----------------|------|---------------|------|------|
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | A or B | Any Y | 2.8 | 11.2 | 3 | 12.8 | ns |
| t _{PHL} | | | 2.8 | 11.2 | 3 | 12.8 | |
| t _{PLH} | \bar{A}/B | Any Y | 4.5 | 18.1 | 4.9 | 16.5 | ns |
| t _{PHL} | | | 4.5 | 18.1 | 4.9 | 16.5 | |
| t _{PLH} | \bar{G} | Any Y | 4.2 | 16.7 | 4.5 | 15.2 | ns |
| t _{PHL} | | | 4.2 | 16.7 | 4.5 | 15.2 | |

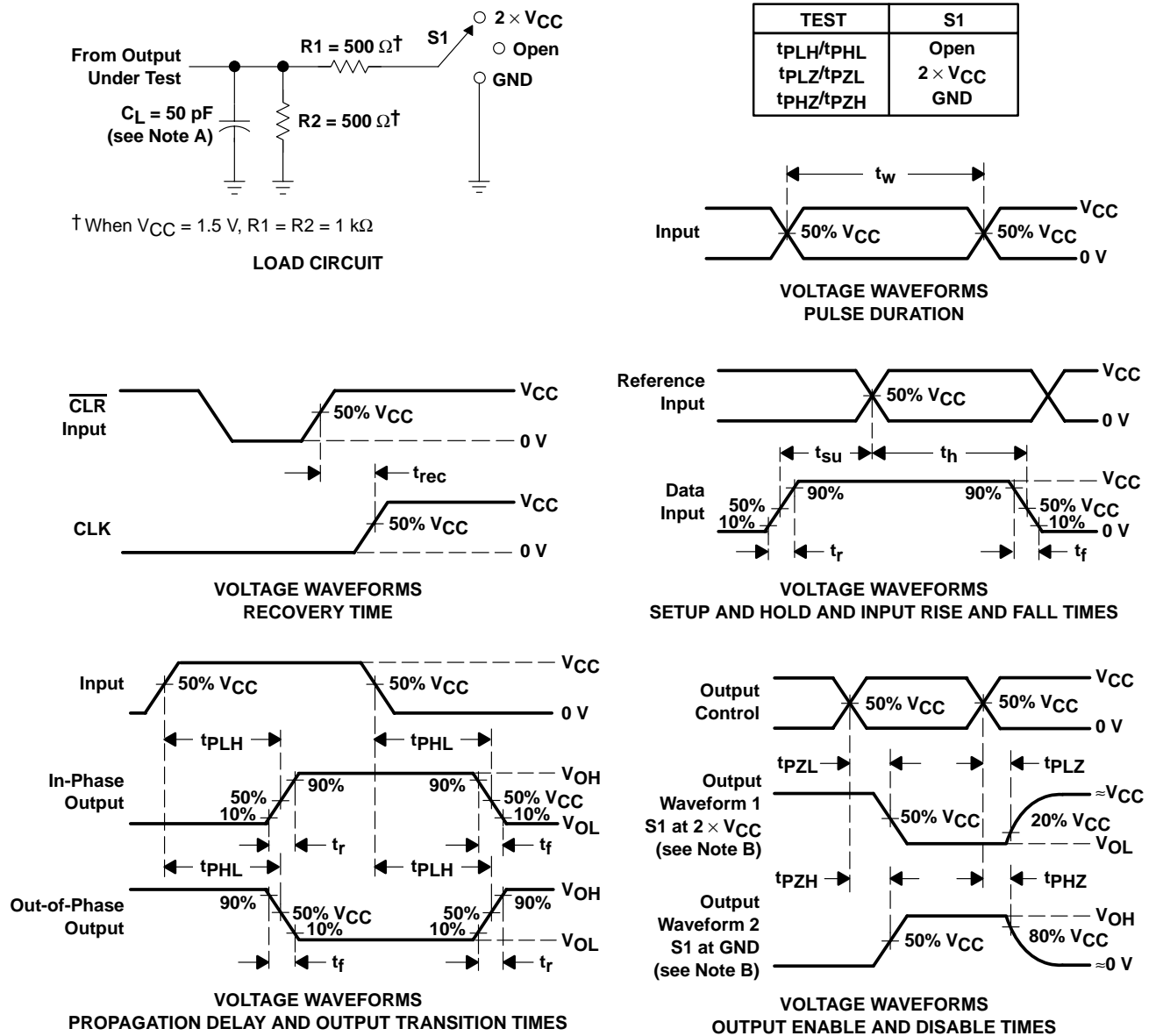
switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | -55°C to 125°C | | -40°C to 85°C | | UNIT |
|------------------|--------------|-------------|----------------|------|---------------|------|------|
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | A or B | Any Y | 2 | 8 | 2.2 | 7.3 | ns |
| t _{PHL} | | | 2 | 8 | 2.2 | 7.3 | |
| t _{PLH} | \bar{A}/B | Any Y | 3.2 | 12.9 | 3.5 | 11.7 | ns |
| t _{PHL} | | | 3.2 | 12.9 | 3.5 | 11.7 | |
| t _{PLH} | \bar{G} | Any Y | 3 | 11.9 | 3.2 | 10.8 | ns |
| t _{PHL} | | | 3 | 11.9 | 3.2 | 10.8 | |

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

| PARAMETER | TYP | UNIT |
|---|-----|------|
| C _{pd} Power dissipation capacitance | 149 | pF |

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and test-fixture capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r = 3$ ns, $t_f = 3$ ns. Phase relationships between waveforms are arbitrary.
 D. For clock inputs, f_{max} is measured with the input duty cycle at 50%.
 E. The outputs are measured one at a time with one input transition per measurement.
 F. t_{PLH} and t_{PHL} are the same as t_{pd} .
 G. t_{PZL} and t_{PZH} are the same as t_{en} .
 H. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 I. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|---------|
| CD74AC158M | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AC158M | |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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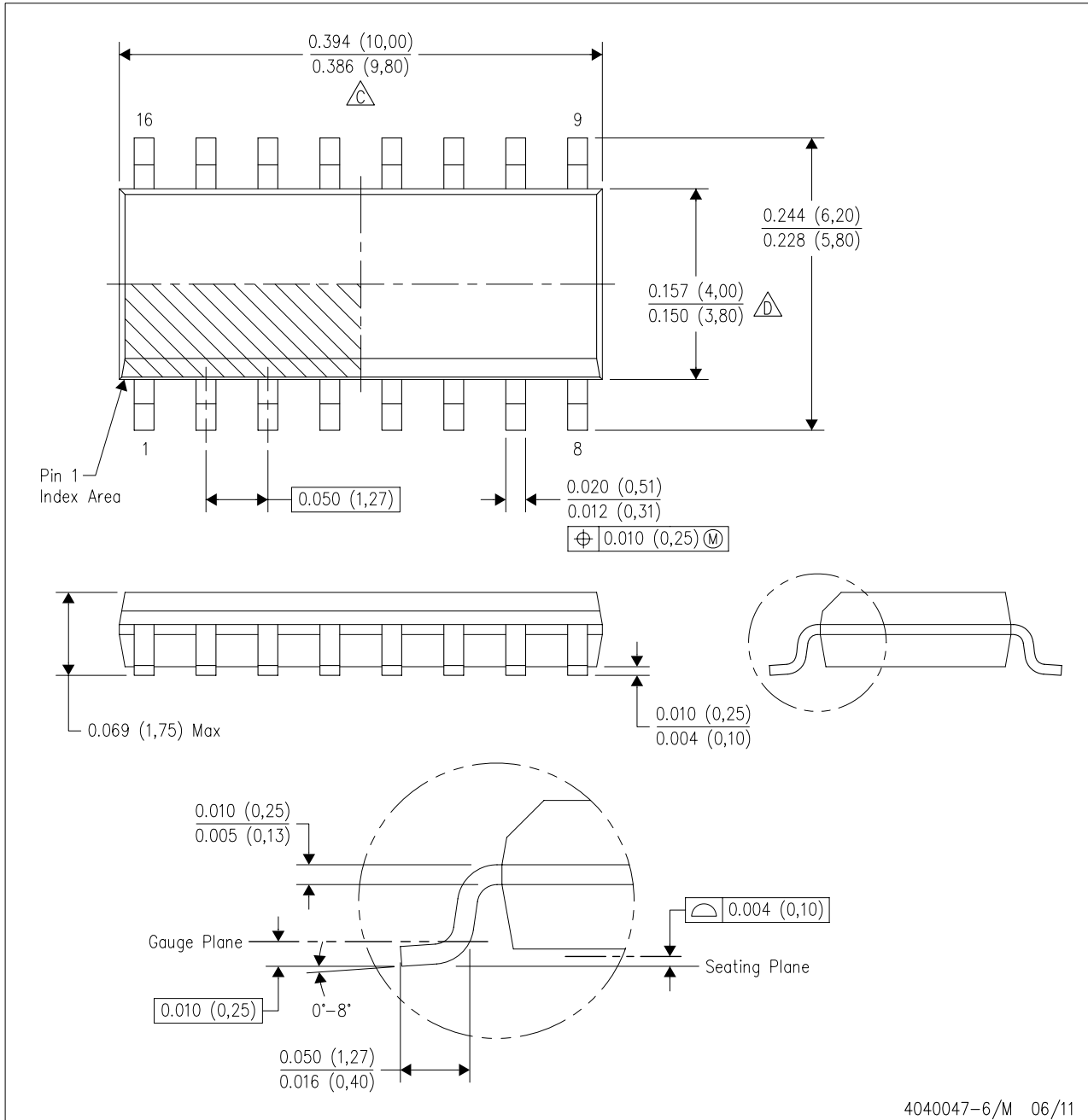
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10-Jun-2014

MECHANICAL DATA

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



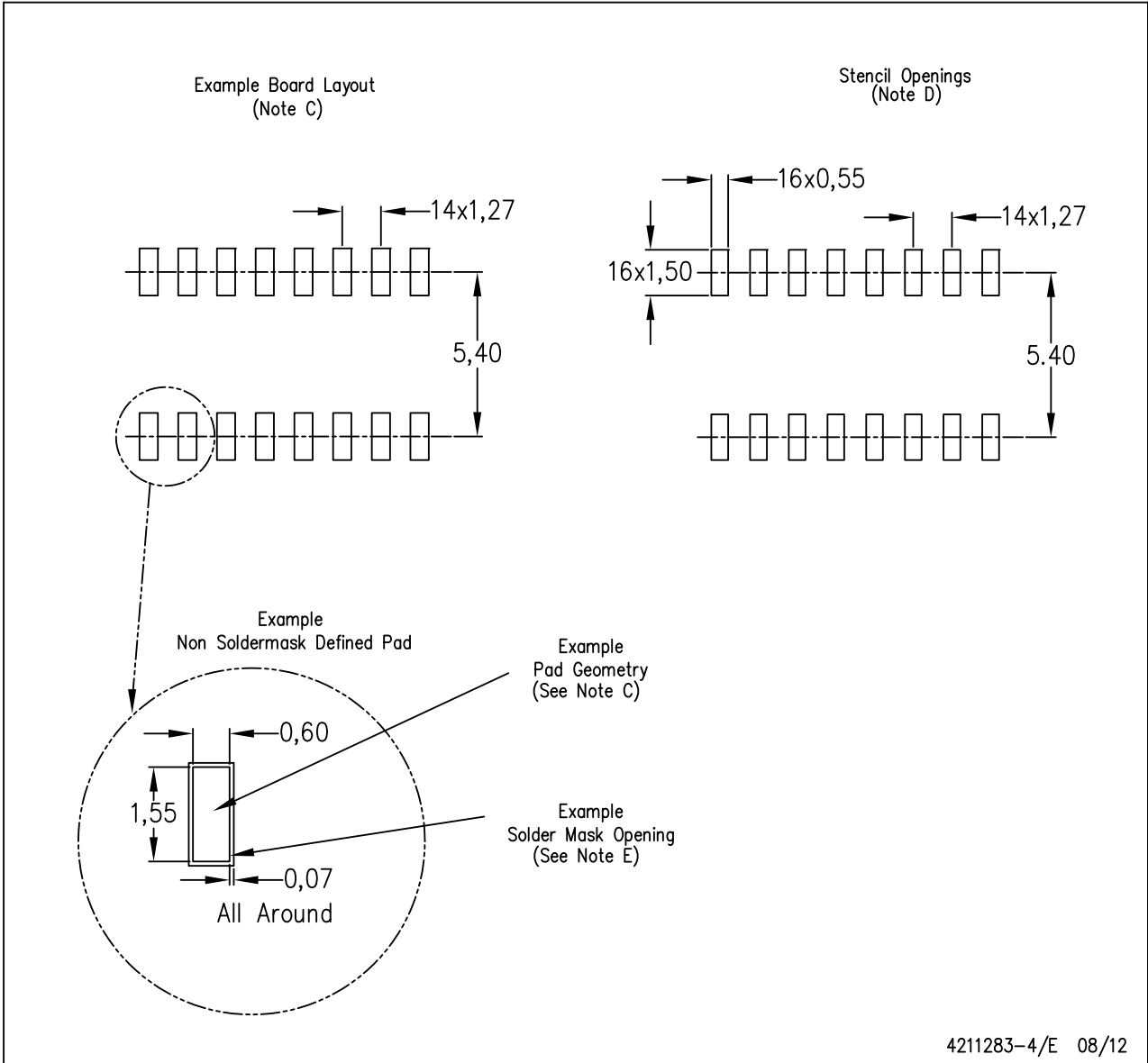
4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

LAND PATTERN DATA

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4211283-4/E 08/12

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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